

# ACPL-P314 and ACPL-W314

## 0.6 Amp Output Current IGBT Gate Driver Optocoupler



### Data Sheet



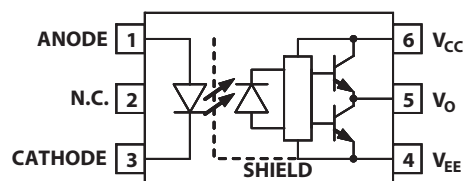
#### Description

The ACPL-P314/W314 consists of a GaAsP LED optically coupled to an integrated circuit with a power output stage. These optocouplers are ideally suited for driving power IGBTs and MOSFETs used in motor control inverter applications. The high operating voltage range of the output stage provides the drive voltages required by gate controlled devices. The voltage and current supplied by this optocoupler makes it ideally suited for directly driving small or medium power IGBTs.

#### Applications

- Isolated IGBT/Power MOSFET gate drive
- AC and brushless DC motor drives
- Industrial inverters
- Inverter for home appliances
- Induction cooker
- Switching Power Supplies (SPS)

#### Functional Diagram



Truth Table	
LED	VO
OFF	LOW
ON	HIGH

Note: A 0.1  $\mu$ F bypass capacitor must be connected between pins V<sub>CC</sub> and V<sub>EE</sub>.

#### Features

- High speed response.
- Ultra high CMR.
- Bootstrappable supply current.
- Available in Stretched SO-6 package
- Package Clearance/Creepage at 8mm (ACPL-W314)
- Safety Approval:  
UL1577 recognized with 3750 Vrms for 1 minute for ACPL-P314 and 5000 Vrms for 1 minute for ACPL-W314.  
CSA Approved.  
IEC/EN/DIN EN 60747-5-2 Approved  
V<sub>IORM</sub> = 891V<sub>peak</sub> for ACPL-P314  
V<sub>IORM</sub> = 1140V<sub>peak</sub> for ACPL-W314

#### Specifications

- 0.6 A maximum peak output current.
- 0.4 A minimum peak output current.
- 0.7  $\mu$ s maximum propagation delay over temperature range.
- I<sub>CC(max)</sub> = 3 mA maximum supply current.
- 25 kV/ $\mu$ s minimum common mode rejection (CMR) at V<sub>CM</sub> = 1500 V.
- Wide V<sub>CC</sub> operating range: 10 V to 30 V over temperature range.
- Wide operating temperature range: -40°C to 100°C.



**CAUTION:** It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

## Ordering Information

ACPL-P314 is UL Recognized with 3750 Vrms for 1 minute per UL1577. ACPL-W314 is UL Recognized with 5000 Vrms for 1 minute per UL1577.

Part number	Option	Package	Surface Mount	Tape & Reel	UL 5000 Vrms /		Quantity
	RoHS Compliant				1 Minute rating	IEC/EN/DIN EN 60747-5-2	
ACPL-P314	-000E	Stretched SO-6	X				100 per tube
	-500E		X	X			1000 per reel
	-060E		X			X	100 per tube
	-560E		X	X		X	1000 per reel
ACPL-W314	-000E	Stretched SO-6	X		X		100 per tube
	-500E		X	X	X		1000 per reel
	-060E		X		X	X	100 per tube
	-560E		X	X	X	X	1000 per reel

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

ACPL-P314-560E to order product of Stretched SO-6 Surface Mount package in Tape and Reel packaging with IEC/EN/DIN EN 60747-5-2 Safety Approval in RoHS compliant.

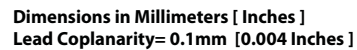
Example 2:

ACPL-P314-000E to order product of Stretched SO-6 Surface Mount package in tube packaging and RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

Remarks: The notation '#XXX' is used for existing products, while (new) products launched since 15th July 2001 and RoHS compliant option will use '-XXxE'.

## ACPL-P314 Stretched SO-6 Package



**Dimensions in millimeters [Inches]**  
**Lead Coplanarity=0.1mm [0.004 Inches]**

## Recommended Pb-Free IR Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision). Non-Halide Flux should be used.

## Regulatory Information

The ACPL-P314/W314 is approved by the following organizations:

### IEC/EN/DIN EN 60747-5-2 (Option 060 only)

Approval under:  
IEC 60747-5-5:2007

### UL

Approval under UL 1577 component recognition program up to  $V_{ISO} = 3750 V_{RMS}$  for the ACPL-P314 and  $V_{ISO} = 5000 V_{RMS}$  for the ACPL-W314, File E55361.

### CSA

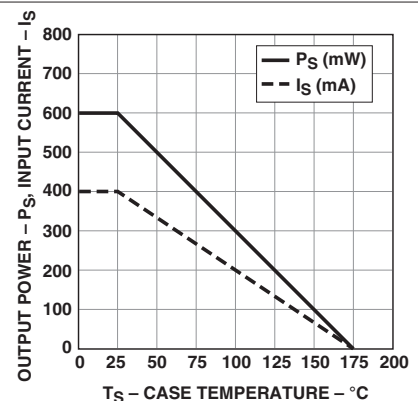
Approval under CSA Component Acceptance Notice #5, File CA 88324.

**Table 1. IEC/EN/DIN EN 60747-5-2 Insulation Related Characteristics\* (ACPL-P314/W314 Option 060)**

Description	Symbol	ACPL-W14	ACPL-P314	Units
Installation classification per DIN VDE 0110/1.89, Table 1				
for rated mains voltage $\leq 150 V_{rms}$		I-IV	I-IV	
for rated mains voltage $\leq 300 V_{rms}$		I-IV	I-IV	
for rated mains voltage $\leq 450 V_{rms}$		I-IV	I-III	
for rated mains voltage $\leq 600 V_{rms}$		I-IV	I-III	
for rated mains voltage $\leq 1000 V_{rms}$		I-III		
Climatic Classification		55/100/21	55/100/21	
Pollution Degree (DIN VDE 0110/1.89)		2	2	
Maximum Working Insulation Voltage	$V_{IORM}$	1140	891	$V_{peak}$
Input to Output Test Voltage, Method b* $V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ sec Partial Discharge $< 5$ pC,	$V_{PR}$	2137	1670	$V_{peak}$
Input to Output Test Voltage, Method a* $V_{IORM} \times 1.6 = V_{PR}$ , Type and sample test, $t_m = 10$ sec, Partial Discharge $< 5$ pC	$V_{PR}$	1824	1426	$V_{peak}$
Highest Allowable Overvoltage* (Transient Overvoltage, $t_{ini} = 60$ sec)	$V_{IOTM}$	8000	6000	$V_{peak}$
Safety Limiting Values (Maximum values allowed in the event of a failure)				
Case Temperature	$T_S$	175	175	$^{\circ}C$
Input Current**	$I_{S,INPUT}$	230	230	mA
Output Power **	$P_{S,OUTPUT}$	600	600	mW
Insulation Resistance at $T_S$ , $V_{IO} = 500$ V	$R_S$	$\leq 10^9$	$\leq 10^9$	$\Omega$

\* Refer to the optocoupler section of the Isolation and Control Components Designer's Catalog, under Product Safety Regulations section, (IEC/EN/DIN EN 60747-5-2) for a detailed description of Method a and Method b partial discharge test profiles.

\*\* Refer to the following figure for dependence of  $P_S$  and  $I_S$  on ambient temperature.



**Table 2. Insulation and Safety Related Specifications**

Parameter	Symbol	ACPL-		Unit	Conditions
		P314	W314		
Minimum External Air Gap (External Clearance)	L(101)	7.0	8.0	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (External Creepage)	L(102)	8.0	8.0	mm	Measured from input terminals to output terminals, shortest distance path along body.
Minimum Internal Plastic Gap (Internal Clearance)		0.08	0.08	mm	Through insulation distance conductor to conductor, usually the straight line distance thickness between the emitter and detector.
Minimum Internal Tracking (Internal Creepage)		NA	NA	mm	Measured from input terminals to output terminals, along internal cavity.
Tracking Resistance (Comparative Tracking Index)	CTI	>175	>175	V	DIN IEC 112/VDE 0303 Part 1
Isolation Group		IIIa	IIIa		Material Group (DIN VDE 0110, 1/89, Table 1)

**Table 3. Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Units	Note
Storage Temperature	T <sub>S</sub>	-55	125	°C	
Operating Temperature	T <sub>A</sub>	-40	100	°C	
Average Input Current	I <sub>F(AVG)</sub>		25	mA	1
Peak Transient Input Current ( $<1\ \mu\text{s}$ pulse width, 300pps)	I <sub>F(TRAN)</sub>		1.0	A	
Reverse Input Voltage	V <sub>R</sub>		5	V	
“High” Peak Output Current	I <sub>OH(PEAK)</sub>		0.6	A	2
“Low” Peak Output Current	I <sub>OL(PEAK)</sub>		0.6	A	2
Supply Voltage	V <sub>CC</sub> - V <sub>EE</sub>	-0.5	35	V	
Output Voltage	V <sub>O(PEAK)</sub>	-0.5	V <sub>CC</sub>	V	
Output Power Dissipation	P <sub>O</sub>		250	mW	3
Input Power Dissipation	P <sub>I</sub>		45	mW	4
Lead Solder Temperature		260°C for 10 sec., 1.6 mm below seating plane			
Solder Reflow Temperature Profile		See Package Outline Drawings section			

**Table 4. Recommended Operating Conditions**

Parameter	Symbol	Min.	Max.	Units	Note
Power Supply	V <sub>CC</sub> - V <sub>EE</sub>	10	30	V	
Input Current (ON)	I <sub>F(ON)</sub>	8	12	mA	
Input Voltage (OFF)	V <sub>F(OFF)</sub>	- 3.6	0.8	V	
Operating Temperature	T <sub>A</sub>	- 40	100	°C	

Notes:

- Derate linearly above 70°C free air temperature at a rate of 0.3 mA/°C.
- Maximum pulse width = 10  $\mu\text{s}$ , maximum duty cycle = 0.2%. This value is intended to allow for component tolerances for designs with I<sub>O</sub> peak minimum = 0.4 A. See Application section for additional details on limiting I<sub>OL</sub> peak.
- Derate linearly above 85°C, free air temperature at the rate of 4.0 mW/°C.
- Input power dissipation does not require derating.

**Table 5. Electrical Specifications (DC)**

Over recommended operating conditions unless otherwise specified.

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions	Fig.	Note
High Level Output Current	$I_{OH}$	0.2			A	$V_O = V_{CC} - 4$	2	1
		0.4	0.5		A	$V_O = V_{CC} - 10$	3	2
Low Level Output Current	$I_{OL}$	0.2	0.4		A	$V_O = V_{EE} + 2.5$	5	1
		0.4	0.5		A	$V_O = V_{EE} + 10$	6	2
High Level Output Voltage	$V_{OH}$	$V_{CC} - 4$	$V_{CC} - 1.8$		V	$I_O = -100$ mA	1	3, 4
Low Level Output Voltage	$V_{OL}$		0.4	1	V	$I_O = 100$ mA	4	
High Level Supply Current	$I_{CCH}$		0.7	3	mA	$I_F = 10$ mA	7, 8	5
Low Level Supply Current	$I_{CCL}$		1.2	3	mA	$I_F = 0$ mA	7, 8	5
Threshold Input Current Low to High	$I_{FLH}$			7	mA	$I_O = 0$ mA, $V_O > 5$ V	9, 15	
Threshold Input Voltage High to Low	$V_{FHL}$	0.8			V	$I_O = 0$ mA, $V_O > 5$ V		
Input Forward Voltage	$V_F$	1.2	1.5	1.8	V	$I_F = 10$ mA	16	
Temperature Coefficient of Input Forward Voltage	$\Delta V_F / \Delta T_A$		-1.6		mV/°C	$I_F = 10$ mA		
Input Reverse Breakdown Voltage	$BV_R$	5			V	$I_R = 10$ $\mu$ A		
Input Capacitance	$C_{IN}$		60		pF	$f = 1$ MHz, $V_F = 0$ V		

**Table 6. Switching Specifications (AC)**

Over recommended operating conditions unless otherwise specified.

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions	Fig.	Note
Propagation Delay Time to High Output Level	$t_{PLH}$	0.1	0.2	0.7	$\mu$ s	$R_g = 47\Omega$ , $C_g = 3$ nF, $f = 10$ kHz, Duty Cycle = 50%, $I_F = 8$ mA, $V_{CC} = 30$ V	10, 11, 12, 13, 14, 17	6
Propagation Delay Time to Low Output Level	$t_{PHL}$	0.1	0.3	0.7	$\mu$ s			6
Propagation Delay Difference Between Any Two Parts or Channels	PDD	-0.5		0.5	$\mu$ s			7
Rise Time	$t_R$		50		ns			
Fall Time	$t_F$		50		ns			
Output High Level Common Mode Transient Immunity	$ CM_H $	25			kV/ $\mu$ s	$T_A = 25^\circ\text{C}$ , $V_{CM} = 1500$ V	18	8
Output Low Level Common Mode Transient Immunity	$ CM_L $	25			kV/ $\mu$ s		18	9

Notes:

- Maximum pulse width = 50  $\mu$ s, maximum duty cycle = 0.5%.
- Maximum pulse width = 10  $\mu$ s, maximum duty cycle = 0.2%. This value is intended to allow for component tolerances for designs with  $I_O$  peak minimum = 0.4 A. See Application section for additional details on limiting  $I_{OL}$  peak.
- In this test,  $V_{OH}$  is measured with a DC load current. When driving capacitive load  $V_{OH}$  will approach  $V_{CC}$  as  $I_{OH}$  approaches zero amps.
- Maximum pulse width = 1 ms, maximum duty cycle = 20%.
- The power supply current increases when operating frequency and  $Q_g$  of the driven IGBT increases.
- This load condition approximates the gate load of a 1200 V/25 A IGBT.
- PDD is the difference between  $t_{PHL}$  and  $t_{PLH}$  between any two parts or channels under the same test conditions.
- Common mode transient immunity in the high state is the maximum tolerable  $|dV_{CM}/dt|$  of the common mode pulse  $V_{CM}$  to assure that the output will remain in the high state (i.e.  $V_O > 6.0$  V).
- Common mode transient immunity in a low state is the maximum tolerable  $|dV_{CM}/dt|$  of the common mode pulse,  $V_{CM}$ , to assure that the output will remain in a low state (i.e.  $V_O < 1.0$  V).

**Table 7. Package Characteristics**

Parameter		Symbol	Min.	Typ.	Max.	Units	Test Conditions	Fig.	Note
Input-Output Momentary Withstand Voltage	ACPL-P314	$V_{ISO}$	3750			$V_{rms}$	$T_A = 25^\circ\text{C}$ , $RH < 50\%$ for 1 min.		1, 3
	ACPL-W314		5000						2, 3
Input-Output Resistance		$R_{I-O}$		$10^{12}$			$V_{I-O} = 500\text{ V}$		3
Input-Output Capacitance		$C_{I-O}$		0.6		pF	Freq=1 MHz		

## Notes:

1. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage  $> 4500 V_{rms}$  for 1 second (leakage detection current limit  $I_{I-O} < 5\ \mu\text{A}$ ). This test is performed before 100% production test for partial discharge (method B) shown in the IEC/EN/DIN EN 60747-5-2 Insulation Characteristics Table, if applicable.
2. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage  $> 6000 V_{rms}$  for 1 second (leakage detection current limit  $I_{I-O} < 5\ \text{A}$ ). This test is performed before 100% production test for partial discharge (method B) shown in the IEC/EN/DIN EN 60747-5-2 Insulation Characteristics Table, if applicable.
3. Device considered a two-terminal device: pins on input side shorted together and pins on output side shorted together.

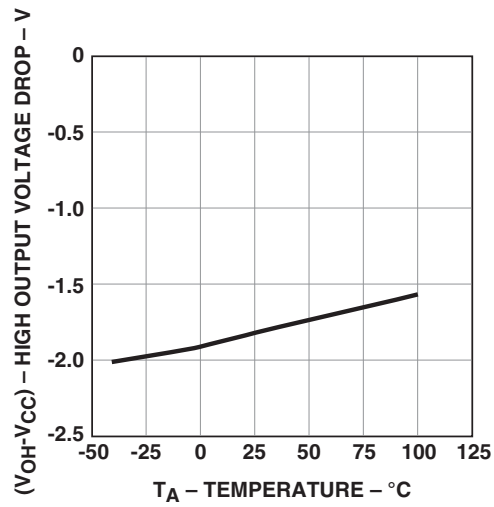


Figure 1.  $V_{OH}$  vs. Temperature.

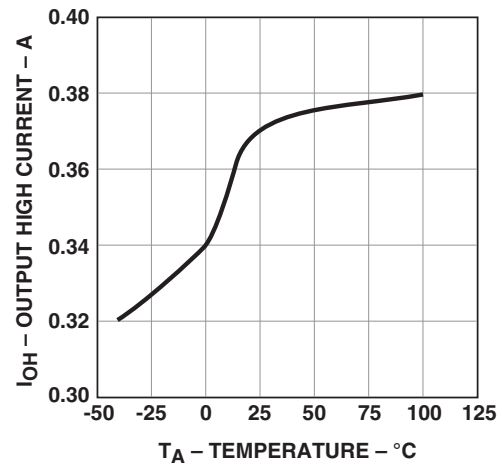


Figure 2.  $I_{OH}$  vs. Temperature.

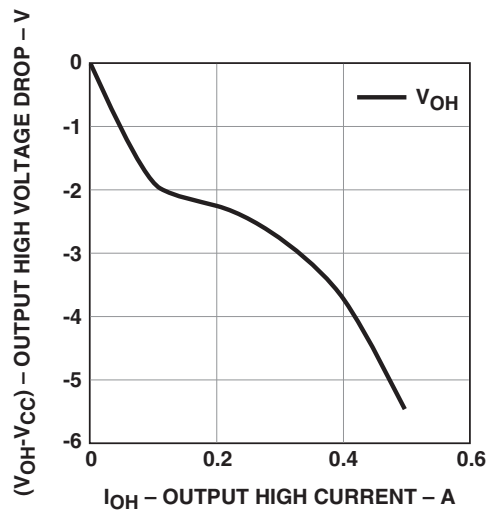


Figure 3.  $V_{OH}$  vs.  $I_{OH}$ .

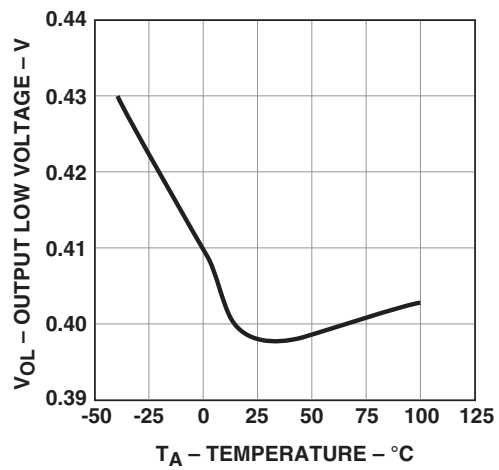


Figure 4.  $V_{OL}$  vs. Temperature.

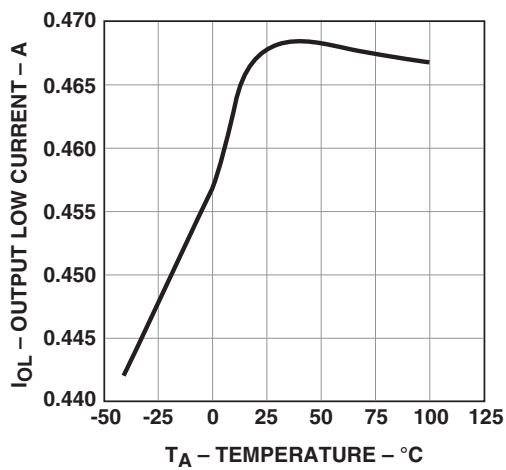


Figure 5.  $I_{OL}$  vs. Temperature.

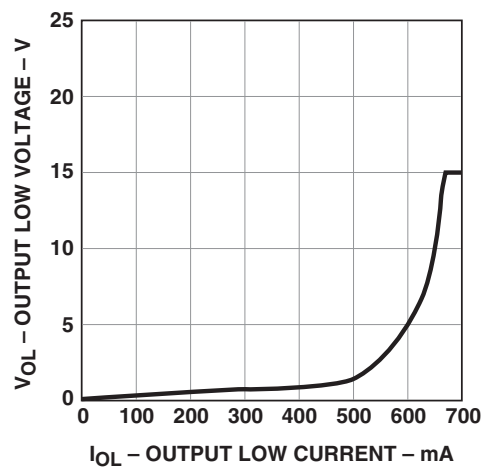


Figure 6.  $V_{OL}$  vs.  $I_{OL}$ .



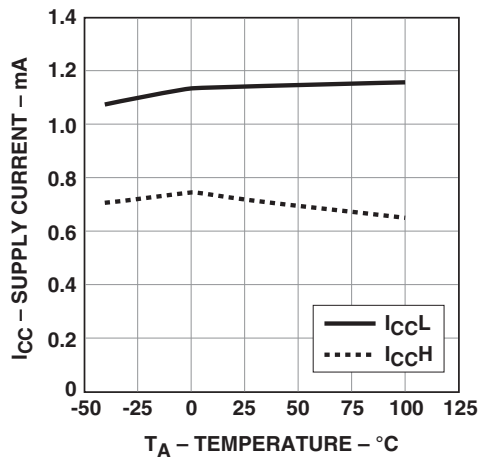


Figure 7.  $I_{CC}$  vs. Temperature.

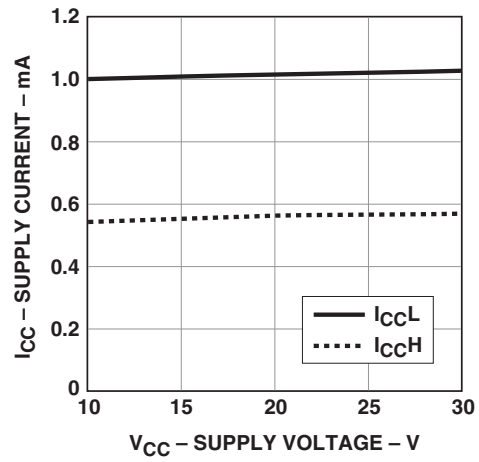


Figure 8.  $I_{CC}$  vs.  $V_{CC}$ .

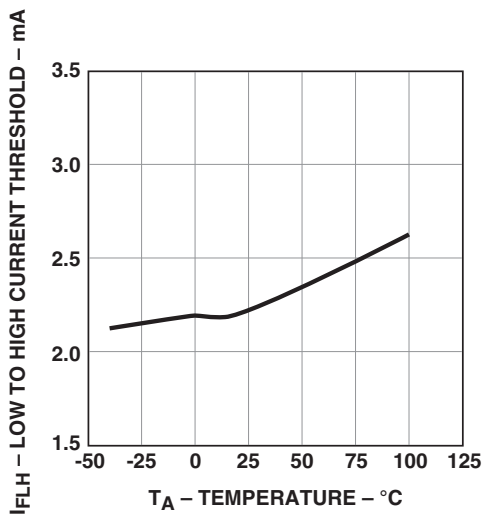


Figure 9.  $I_{FLH}$  vs. Temperature.

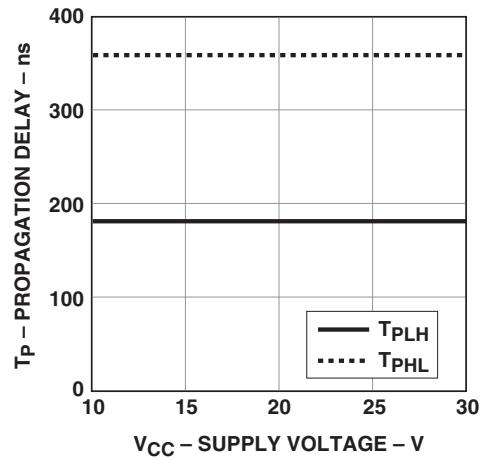


Figure 10. Propagation Delay vs.  $V_{CC}$ .

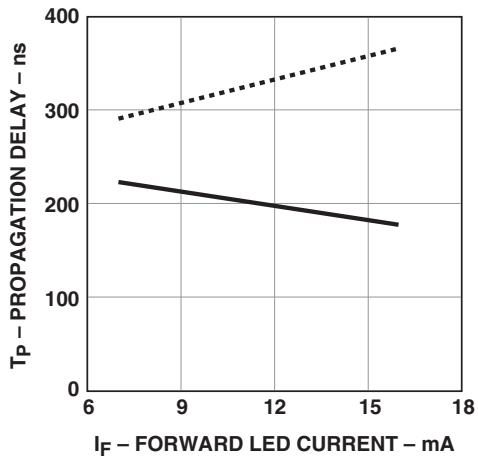


Figure 11. Propagation Delay vs.  $I_F$ .

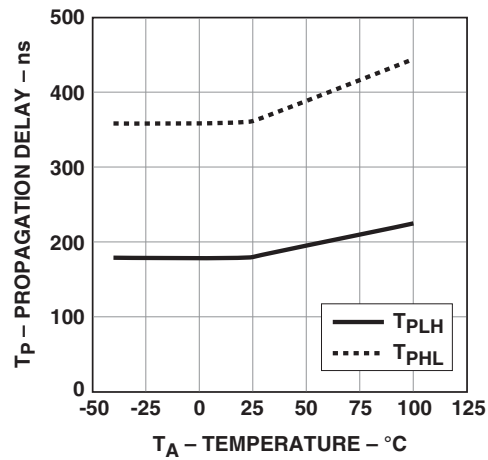


Figure 12. Propagation Delay vs. Temperature.

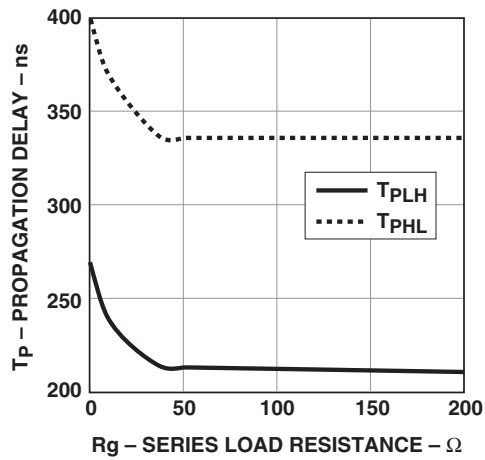


Figure 13. Propagation Delay vs.  $R_g$ .

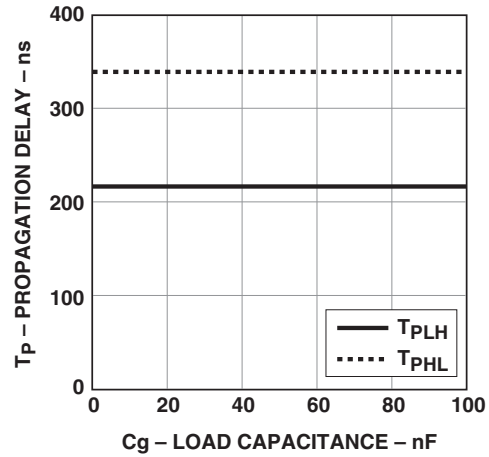


Figure 14. Propagation Delay vs.  $C_g$ .

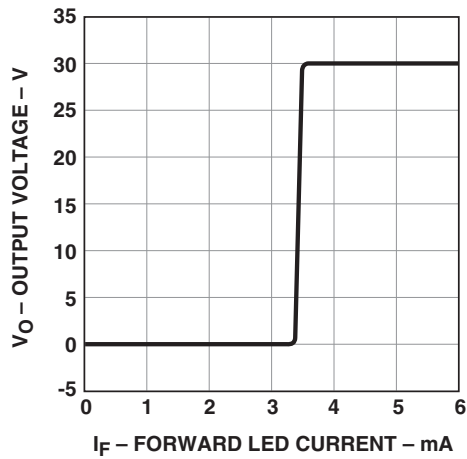


Figure 15. Transfer Characteristics.

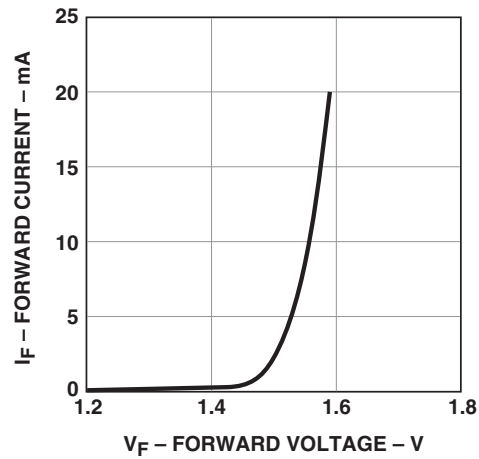


Figure 16. Input Current vs. Forward Voltage.

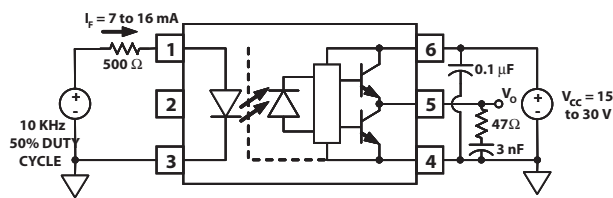


Figure 17. Propagation Delay Test Circuit and Waveforms.

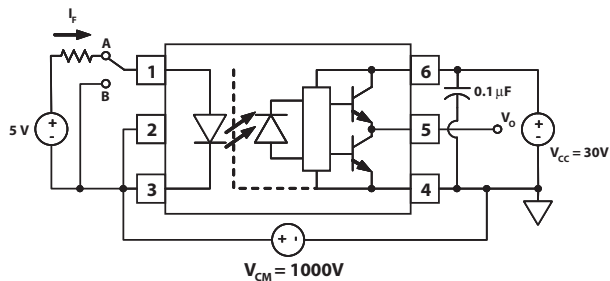


Figure 18. CMR Test Circuit and Waveforms.

## Applications Information

### Eliminating Negative IGBT Gate Drive

To keep the IGBT firmly off, the ACPL-P314/W314 has a very low maximum  $V_{OL}$  specification of 1.0 V. Minimizing  $R_g$  and the lead inductance from the ACPL-P314/W314 to the IGBT gate and emitter (possibly by mounting the ACPL-P314/W314 on a small PC board directly above the IGBT) can eliminate the need for negative IGBT gate drive in many applications as shown in Figure 19. Care should be taken with such a PC board design to avoid routing the IGBT collector or emitter traces close to the ACPL-P314/W314 input as this can result in unwanted coupling of transient signals into the input of ACPL-P314/W314 and degrade performance. (If the IGBT drain must be routed near the ACPL-P314/W314 input, then the LED should be reverse biased when in the off state, to prevent the transient signals coupled from the IGBT drain from turning on the ACPL-P314/W314.

### Selecting the Gate Resistor ( $R_g$ )

Step 1: Calculate  $R_g$  minimum from the  $I_{OL}$  peak specification. The IGBT and  $R_g$  in Figure 19 can be analyzed as a simple RC circuit with a voltage supplied by the ACPL-P314/W314.

$$R_g \geq \frac{V_{CC} - V_{OL}}{I_{OLPEAK}} \\ = \frac{24 - 5}{0.6} \\ = 32 \Omega$$

The  $V_{OL}$  value of 5 V in the previous equation is the  $V_{OL}$  at the peak current of 0.6A. (See Figure 6).

Step 2: Check the ACPL-P314/W314 power dissipation and increase  $R_g$  if necessary. The ACPL-P314/W314 total power dissipation ( $P_T$ ) is equal to the sum of the emitter power ( $P_E$ ) and the output power ( $P_O$ ).

$$P_T = P_E + P_O$$

$$P_E = I_F \cdot V_F \cdot \text{DutyCycle}$$

$$P_O = P_{O(BIAS)} + P_{O(SWITCHING)} = I_{CC} \cdot V_{CC} + E_{SW} (R_g; Q_g) \cdot f \\ = (I_{CCBIAS} + K_{ICC} \cdot Q_g \cdot f) \cdot V_{CC} + E_{SW} (R_g; Q_g) \cdot f$$

where  $K_{ICC} \cdot Q_g \cdot f$  is the increase in  $I_{CC}$  due to switching and  $K_{ICC}$  is a constant of 0.001 mA/(nC\*kHz). For the circuit in Figure 19 with  $I_F$  (worst case) = 10 mA,  $R_g = 32 \Omega$ , Max Duty Cycle = 80%,  $Q_g = 100$  nC,  $f = 20$  kHz and  $T_{AMAX} = 85^\circ\text{C}$ :

$$P_E = 10 \text{ mA} \cdot 1.8 \text{ V} \cdot 0.8 = 14 \text{ mW}$$

$$P_O = (3 \text{ mA} + (0.001 \text{ mA/nC} \cdot \text{kHz}) \cdot 20 \text{ kHz} \cdot 100 \text{ nC}) \cdot 24 \text{ V} + \\ 0.4 \mu\text{J} \cdot 20 \text{ kHz} = 128 \text{ mW} \leq 250 \text{ mW} (P_{O(MAX)} @ 85^\circ\text{C})$$

The value of 3 mA for  $I_{CC}$  in the previous equation is the max.  $I_{CC}$  over entire operating temperature range.

Since  $P_O$  for this case is less than  $P_{O(MAX)}$ ,  $R_g = 32 \Omega$  is alright for the power dissipation.

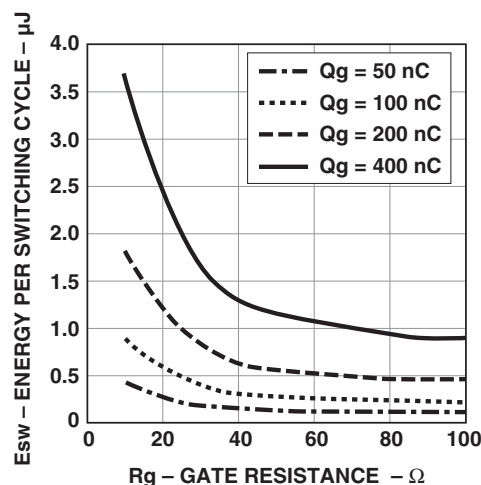


Figure 20. Energy Dissipated in the ACPL-P314/W314 and for Each IGBT Switching Cycle.

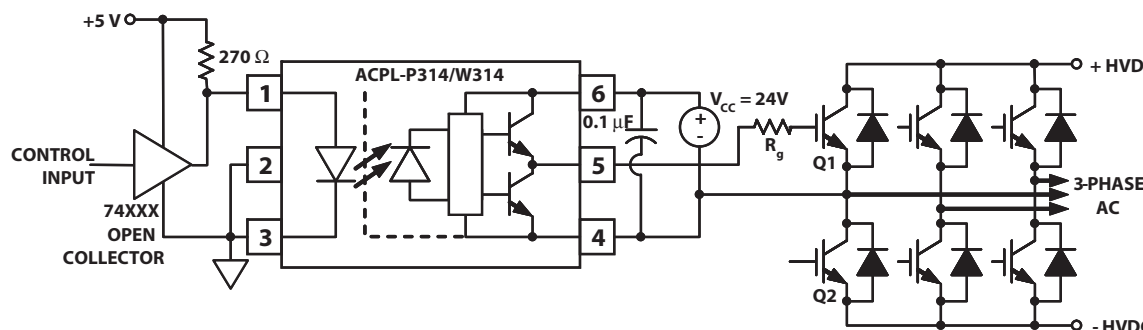


Figure 19. Recommended LED Drive and Application Circuit for ACPL-P314/W314

## LED Drive Circuit Considerations for Ultra High CMR Performance

Without a detector shield, the dominant cause of optocoupler CMR failure is capacitive coupling from the input side of the optocoupler, through the package, to the detector IC as shown in Figure 21. The ACPL-P314/W314 improves CMR performance by using a detector IC with an optically transparent Faraday shield, which diverts the capacitively coupled current away from the sensitive IC circuitry. However, this shield does not eliminate the capacitive coupling between the LED and optocoupler pins 5-8 as shown in Figure 22. This capacitive coupling causes perturbations in the LED current during common mode transients and becomes the major source of CMR failures for a shielded optocoupler. The main design objective of a high CMR LED drive circuit becomes keeping the LED in the proper state (on or off) during common mode transients. For example, the recommended application circuit (Figure 19), can achieve 10 kV/ $\mu$ s CMR while minimizing component complexity.

Techniques to keep the LED in the proper state are discussed in the next two sections.

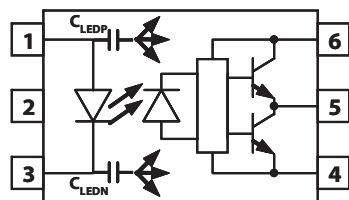


Figure 21. Optocoupler Input to Output Capacitance Model for Unshielded Optocouplers.

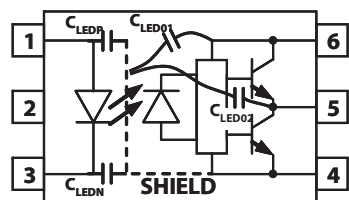


Figure 22. Optocoupler Input to Output Capacitance Model for Shielded Optocouplers.

## CMR with the LED On (CMR<sub>H</sub>)

A high CMR LED drive circuit must keep the LED on during common mode transients. This is achieved by overdriving the LED current beyond the input threshold so that it is not pulled below the threshold during a transient. A minimum LED current of 8 mA provides adequate margin over the maximum  $I_{FLH}$  of 5 mA to achieve 10 kV/ $\mu$ s CMR.

## CMR with the LED Off (CMR<sub>L</sub>)

A high CMR LED drive circuit must keep the LED off ( $V_F \leq V_{F(OFF)}$ ) during common mode transients. For example, during a  $-dV_{CM}/dt$  transient in Figure 23, the current flowing through  $C_{LEDP}$  also flows through the  $R_{SAT}$  and  $V_{SAT}$  of the logic gate. As long as the low state voltage developed across the logic gate is less than  $V_{F(OFF)}$  the LED will remain off and no common mode failure will occur.

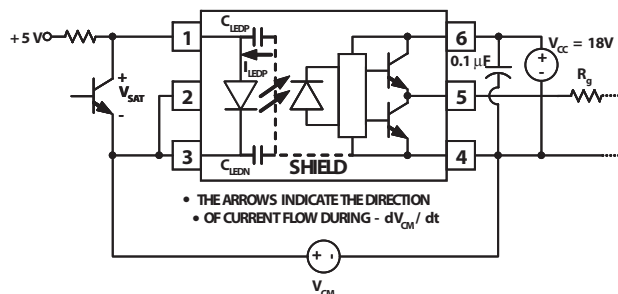


Figure 23. Equivalent Circuit for Figure 17 During Common Mode Transient.

The open collector drive circuit, shown in Figure 24, can not keep the LED off during a  $+dV_{CM}/dt$  transient, since all the current flowing through  $C_{LEDN}$  must be supplied by the LED, and it is not recommended for applications requiring ultra high CMR1 performance. The alternative drive circuit which like the recommended application circuit (Figure 19), does achieve ultra high CMR performance by shunting the LED in the off state.

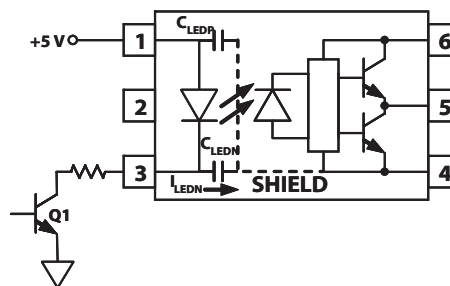


Figure 24. Not Recommended Open Collector Drive Circuit.

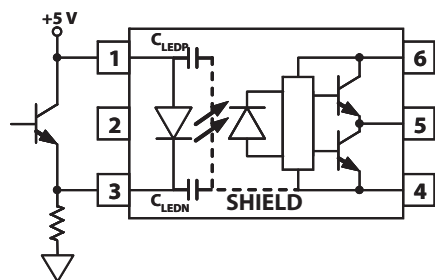
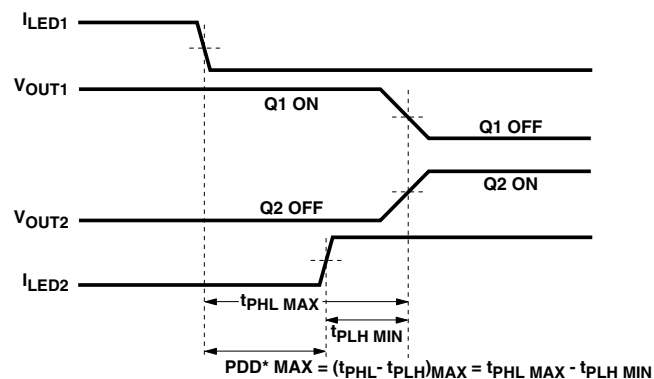


Figure 25. Recommended LED Drive Circuit for Ultra-High CMR Dead Time and Propagation Delay Specifications.

## Dead Time and Propagation Delay Specifications

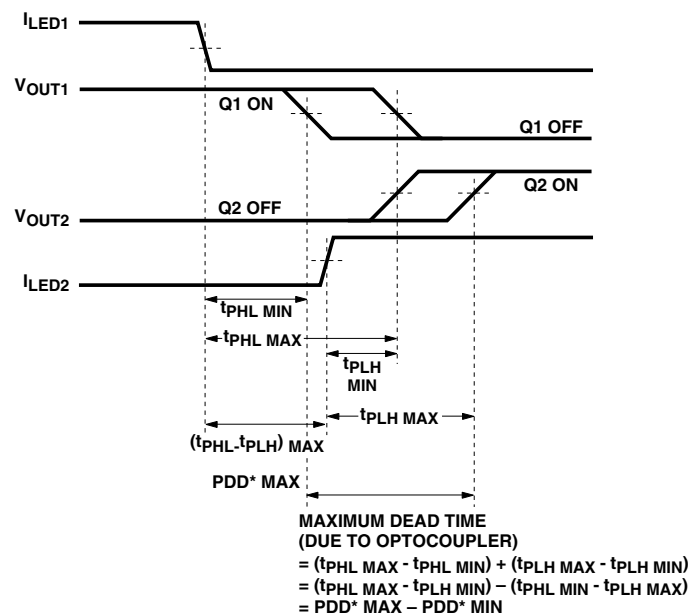
The ACPL-P314/W314 includes a Propagation Delay Difference (PDD) specification intended to help designers minimize “dead time” in their power inverter designs. Dead time is the time high and low side power transistors are off. Any overlap in Q1 and Q2 conduction will result in large currents flowing through the power devices from the high voltage to the low-voltage motor rails. To minimize dead time in a given design, the turn on of LED2 should be delayed (relative to the turn off of LED1) so that under worst-case conditions, transistor Q1 has just turned off when transistor Q2 turns on, as shown in Figure 26. The amount of delay necessary to achieve this condition is equal to the maximum value of the propagation delay difference specification, PDD max, which is specified to be 500 ns over the operating temperature range of -40° to 100°C.



\*PDD = PROPAGATION DELAY DIFFERENCE  
NOTE: FOR PDD CALCULATIONS THE PROPAGATION DELAYS ARE TAKEN AT THE SAME TEMPERATURE AND TEST CONDITIONS.

Figure 26. Minimum LED Skew for Zero Dead Time.

Delaying the LED signal by the maximum propagation delay difference ensures that the minimum dead time is zero, but it does not tell a designer what the maximum dead time will be. The maximum dead time is equivalent to the difference between the maximum and minimum propagation delay difference specification as shown in Figure 27. The maximum dead time for the ACPL-P314/W314 is 1 μs (= 0.5 μs - (-0.5 μs)) over the operating temperature range of -40°C to 100°C.



\*PDD = PROPAGATION DELAY DIFFERENCE  
NOTE: FOR DEAD TIME AND PDD CALCULATIONS ALL PROPAGATION DELAYS ARE TAKEN AT THE SAME TEMPERATURE AND TEST CONDITIONS.

Figure 27. Waveforms for Dead Time.

Note that the propagation delays used to calculate PDD and dead time are taken at equal temperatures and test conditions since the optocouplers under consideration are typically mounted in close proximity to each other and are switching identical IGBTs.

## Thermal Model for ACPL-P314/W314 Stretched-SO6 Package Optocoupler

### Definitions

R<sub>11</sub>: Junction to Ambient Thermal Resistance of LED due to heating of LED

R<sub>12</sub>: Junction to Ambient Thermal Resistance of LED due to heating of Detector (Output IC)

R<sub>21</sub>: Junction to Ambient Thermal Resistance of Detector (Output IC) due to heating of LED.

R<sub>22</sub>: Junction to Ambient Thermal Resistance of Detector (Output IC) due to heating of Detector (Output IC).

P<sub>1</sub>: Power dissipation of LED (W).

P<sub>2</sub>: Power dissipation of Detector / Output IC (W).

T<sub>1</sub>: Junction temperature of LED (°C).

T<sub>2</sub>: Junction temperature of Detector (°C).

T<sub>a</sub>: Ambient temperature.

ΔT<sub>1</sub>: Temperature difference between LED junction and ambient (°C).

ΔT<sub>2</sub>: Temperature difference between Detector junction and ambient.

Ambient Temperature: Junction to Ambient Thermal Resistances were measured approximately 1.25cm above optocoupler at ~23°C in still air

### Description

This thermal model assumes that an 6-pin single-channel plastic package optocoupler is soldered into a 7.62 cm x 7.62 cm printed circuit board (PCB). The temperature at the LED and Detector junctions of the optocoupler can be calculated using the equations below.

$$T_1 = (R_{11} * P_1 + R_{12} * P_2) + T_a \quad -- (1)$$

$$T_2 = (R_{21} * P_1 + R_{22} * P_2) + T_a \quad -- (2)$$

Jedec Specifications	R <sub>11</sub>	R <sub>12</sub> , R <sub>21</sub>	R <sub>22</sub>
low K board	357	150, 166	228
high K board	249	76, 79	159

Notes:

1. Maximum junction temperature for above parts: 125 °C.

For product information and a complete list of distributors, please go to our web site:

[www.avagotech.com](http://www.avagotech.com)

Avago, Avago Technologies, and the A logo are trademarks of Avago Technologies, in the United States and other countries. Data subject to change. Copyright © 2005-2011 Avago Technologies. All rights reserved. Obsoletes AV01-0634EN  
AV02-0158EN - July 14, 2011

**Avago**  
TECHNOLOGIES

# AMEYA360

Components Supply Platform

Authorized Distribution Brand :



Website :

Welcome to visit [www.ameya360.com](http://www.ameya360.com)

Contact Us :

➤ Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd  
Minhang District, Shanghai , China

➤ Sales :

Direct     +86 (21) 6401-6692  
  
Email       amall@ameya360.com  
  
QQ         800077892  
  
Skype      ameyasales1 ameyasales2

➤ Customer Service :

Email       service@ameya360.com

➤ Partnership :

Tel         +86 (21) 64016692-8333  
  
Email      mkt@ameya360.com